



MMDT4403

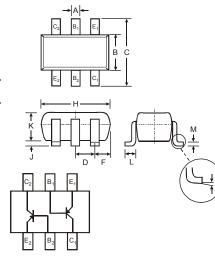
DUAL PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching •
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability • Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C •
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking Information: K2T See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.006 grams (approximate)



SOT-363								
Dim	Min	Мах						
Α	0.10	0.30						
в	1.15	1.35						
С	2.00 2.20							
D	0.65 N	ominal						
F	0.30	0.40						
н	1.80	2.20						
J		0.10						
Κ	0.90	1.00						
L	0.25	0.40						
М	0.10	0.25						
α	0°	8°						
All Din	nensions	in mm						

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage		V _{CBO}	-40	V
Collector-Emitter Voltage		V _{CEO}	-40	V
Emitter-Base Voltage		V _{EBO}	-5.0	V
Collector Current - Continuous	(Note 1)	lc	-600	mA
Power Dissipation	(Note 1, 2)	Pd	200	mW
Thermal Resistance, Junction to Ambient	(Note 1)	$R_{ heta}$ JA	625	°C/W
Operating and Storage Temperature Range		T _j , T _{STG}	-55 to +150	°C

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Maximum combined dissipation. 2.

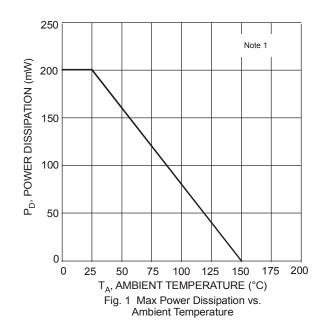
No purposefully added lead. 3.

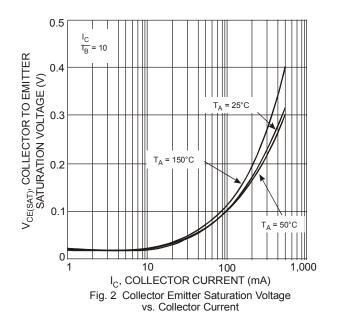
Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

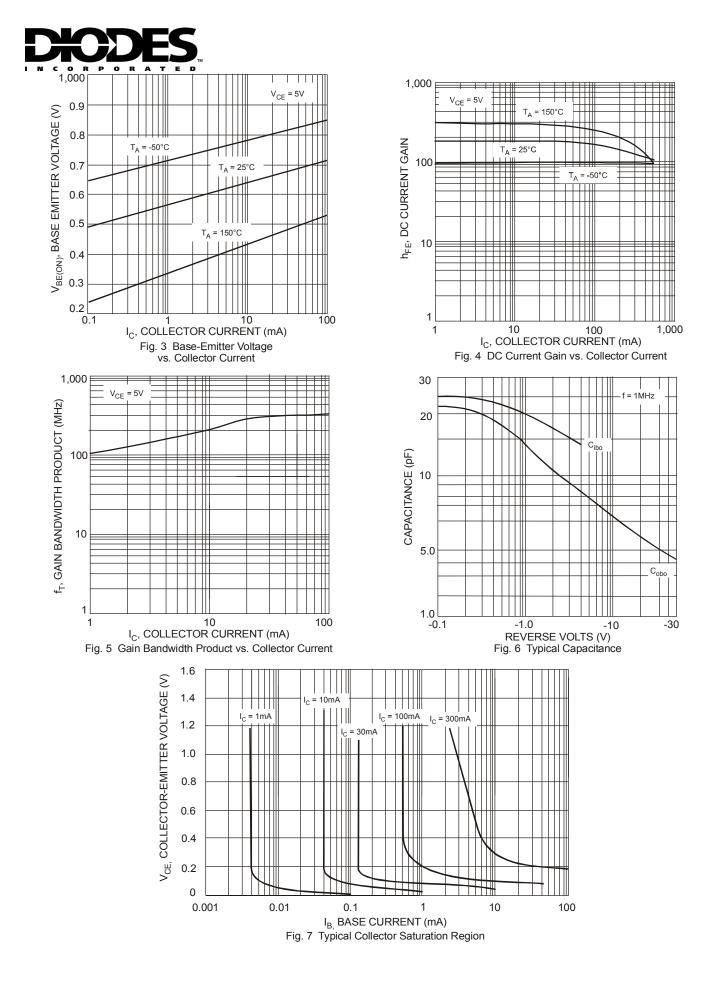


Electrical Characteristics @T _A = 25°C unless otherwise specified									
Characteristic	Symbol	Min	Мах	Unit	Test Condition				
OFF CHARACTERISTICS (Note 6)			1	r	T				
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-40	—	V	$I_{\rm C}$ = -100 μ A, $I_{\rm E}$ = 0				
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-40		V	I _C = -1.0mA, I _B = 0				
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-5.0		V	$I_E = -100 \mu A, I_C = 0$				
Collector Cutoff Current	I _{CEX}	_	-100	nA	V_{CE} = -35V, $V_{EB(OFF)}$ = -0.4V				
Base Cutoff Current	I _{BL}	_	-100	nA	V_{CE} = -35V, $V_{EB(OFF)}$ = -0.4V				
ON CHARACTERISTICS (Note 6)									
DC Current Gain	h _{FE}	30 60 100 100 20	 300	_	$\begin{split} I_{C} &= -100 \mu A, V_{CE} &= -1.0V \\ I_{C} &= -1.0 m A, V_{CE} &= -1.0V \\ I_{C} &= -10 m A, V_{CE} &= -1.0V \\ I_{C} &= -150 m A, V_{CE} &= -2.0V \\ I_{C} &= -500 m A, V_{CE} &= -2.0V \end{split}$				
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	-0.40 -0.75	V	$I_{C} = -150$ mA, $I_{B} = -15$ mA $I_{C} = -500$ mA, $I_{B} = -50$ mA				
Base-Emitter Saturation Voltage	V _{BE(SAT)}	-0.75 —	-0.95 -1.30	V	I _C = -150mA, I _B = -15mA I _C = -500mA, I _B = -50mA				
SMALL SIGNAL CHARACTERISTICS									
Output Capacitance	C _{cb}		8.5	pF	V_{CB} = -10V, f = 1.0MHz, I _E = 0				
Input Capacitance	Ceb		30	pF	V_{EB} = -0.5V, f = 1.0MHz, I _C = 0				
Input Impedance	h _{ie}	1.5	15	kΩ					
Voltage Feedback Ratio	h _{re}	0.1	8.0	x 10 ⁻⁴	V _{CE} = -10V, I _C = -1.0mA,				
Small Signal Current Gain	h _{fe}	60	500	—	f = 1.0kHz				
Output Admittance	h _{oe}	1.0	100	μS					
Current Gain-Bandwidth Product	f _T	200	_	MHz	V _{CE} = -10V, I _C = -20mA, f = 100MHz				
SWITCHING CHARACTERISTICS				_					
Delay Time	t _d	_	15	ns	V _{CC} = -30V, I _C = -150mA,				
Rise Time	tr	_	20	ns	$V_{BE(off)}$ = -2.0V, I_{B1} = -15mA				
Storage Time	ts		225	ns	V _{CC} = -30V, I _C = -150mA,				
-all Time	tf		30	ns	$I_{B1} = I_{B2} = -15 \text{mA}$				

Notes: 6. Short duration pulse test used to minimize self-heating effect.







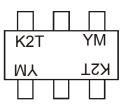


Ordering Information (Note 7)

Device	Packaging	Shipping				
MMDT4403-7-F	SOT-363	3000/Tape & Reel				

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



K2T = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	К	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Feb		Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec

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